

#### 1490nm/1310nm Single Fiber OLT

SPS-43-48H-HP-xDE (x=R, T)



#### **Features**

- Burst receive GPON OLT transceiver
- Small Form Factor Pluggable, Simple SC Connector
- "Fast Signal Detect" feature reduces ranging overhead
- Simplified OLT "reset" timing
- 1490 nm DFB Tx with isolator
- 1310 nm APD Rx
- 2488 Mbps downstream Tx/1244 Mbps upstream Rx
- Single 3.3 V supply
- ITU-T G.984.2 compliant
- 20 km reach; 28 dB link budget
- RoHS-5/6 compliant (lead exemption)

#### **General Parameters**

Table 1 – General Operating Parameters				
Parameter	Minimum	Typical	Maximum	Unit/Conditions
Operating Voltage, Vcc	3.135	3.3	3.465	V
Total Current, Icc	-	-	500	mA
Case Operating Temperature (-RDE)	-20	-	85	C
Case Operating Temperature (-TDE)	-40	-	85	C
Storage Temperature	-40	-	85	C

Table 1 – General Optical Parameters									
Parameter	Minimum	Typical	Maximum	Unit/Conditions					
Back Reflection at 1490 nm	-	-	-20	dB					
Back Reflection at 1310 nm	-	-	-20	dB					
1490 nm to 1310 nm Crosstalk	-	-	-45	dB					



1490nm/1310nm Single Fiber OLT

#### **Functional Characteristics**

The following tables list the performance specifications for the various functional blocks of the integrated optical transceiver module.

Table 2 – Transmitter Specifications (Optical)							
Parameter	Minimum	Typical	Maximum	Unit	Notes		
Average Optical Output Power, Po	1.5	-	5	dBm			
Output Power at Transmit Off	-	-	-40	dBm			
Center Wavelength, λ	1480	1490	1500	nm			
-20 dB Spectral Width	-	-	1	nm			
Side Mode Suppression Ratio (SMSR)	30	-	-	dB			
Extinction Ratio	10	-	-	dB	PRBS 2 <sup>23</sup> -1, NRZ, 50% duty cycle		
Transmitter Output Eye	G	.984.2 Figure	2				
Optical Rise and Fall Time <sup>a</sup> -		-	160	ps	20% to 80%		
Bit Rate	-	2488	-	Mbps			
Tolerance to TX Back Reflection <sup>b</sup>	-15	-	-	dB			

a) 20 to 80% value

b) 1 dB degradation of Rx sensitivity

Table 4 – Transmitter Specifications (Electrical)								
Parameter	Minimum	Typical	Maximum	Unit	Notes			
Input Differential Impedance	80	100	120	Ω				
Single Ended Data Input Swing	300	-	1200	mV				
Tx Disable (LVTTL)	2	-	Vcc	V				
Tx Enable (LVTTL)	0	-	0.8	V				
TX_Fail_High	2.4	-	Vcc	V				
TX_Fail_Normal	0	-	0.4	V				

Table 5 – Receiver Specifications (Optical)								
Parameter	Minimum	Typical	Maximum	Unit	Notes			
Operational Wavelength Range	1260	1310	1360	nm				
Data Rate (burst mode)	-	1244	-	Mbps				
Receiver Burst-Mode Sensitivity	-	-	-28	dBm	At 10 <sup>-10</sup> BER, PRBS 2 <sup>23</sup> -1, 20km fiber			
Receiver Overload	-8	-	-	dBm				
Burst Detect Assert	-	-	-28	dBm				
Receiver Burst Mode Dynamic Range	15	20	-	dB	Input power difference between two subsequent high and low burst data			
Receiver CID Tolerance	72			bits				



#### 1490nm/1310nm Single Fiber OLT

Parameter	Minimum	Typical	Maximum	Unit	Notes
Damage Threshold for Receiver	+3	-	-	dBm	
Maximum Reflectance of Receiver	-	-	-20	dB	

Table 6 – Receiver Specifications (Electrical)								
Parameter	Minimum	Typical	Maximum	Unit	Notes			
PECL Single Ended Data Output Swing	250		900	mV				
(LVPECL)	250	-	800	mv				
Data Output Rise Time	-	250	-	ps	20% to 80%			
Data Output Fall Time	-	250	-	ps	20% to 80%			
Signal Detect Output HIGH	2.4	-	Vcc	V				
Signal Detect Output LOW <sup>a</sup>	0	-	0.4	V				
Signal Detect Response Time	-	-	6.4	ns				

a) Signal Detect assert low when module receive "reset" signal, assert high when incoming burst is detected and latch to high state until next "Reset" signal.

Table 7 – Digital RSSI Timing Specification									
Parameter	Minimum	Typical	Maximum	Unit	Notes				
RSSI Trigger Delay <sup>a</sup>	25	-	-	ns					
RSSI Sampling Time <sup>a</sup>	300	-	-	ns					
Internal I <sup>2</sup> C Delay <sup>a</sup>	-	-	500	us					
Receiver Power DDM (RSSI) Error <sup>b</sup>	-	-	+/- 3	dB					

- a) RSSI\_ACQ input signal rising edge will trigger RSSI sampling, and falling edge will trigger internal digital RSSI information written to I2C. It is recommended that host shall not trigger RSSI\_ACQ input again until RSSI data is valid in I2C from previous RSSI trigger.
- b) RSSI DDM working range is between -10 to -30 dBm. RSSI DDM accuracy is better than +/- 3dB for input power levels between -12 to -30 dBm, the accuracy reduces to +/- 5 dBm for -10 to -12dBm.



# SPS-43-48H-HP-xDE 1490nm/1310nm Single Fiber OLT

#### **Pin Definitions**

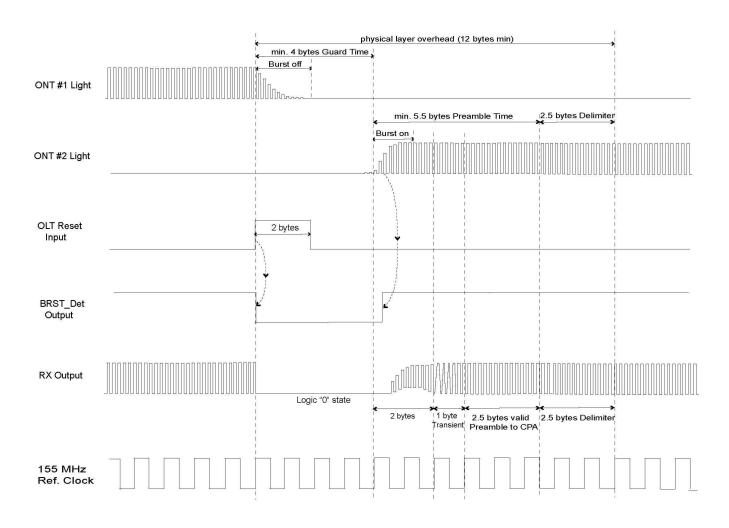
Refer to Table for a description of the function of each I/O pin.

Table 8 - Modu	le Pin Definitions	
Pin Number	Label	Definition
1	Veet	Tx Ground
2	Tx_Fail (Tx_Fault)	Tx Fail Alarm. LVTTL Output Active High
3	Tx_DIS	Tx Disable. LVTTL input. Laser output is disabled when this pin is asserted high or left unconnected. Laser output is enabled when this pin is asserted low.
4	MOD_DEF (2)	2-Wire Serial Data I/O Pin.
5	MOD_DEF (1)	2-Wire Serial Clock Input.
6	MOD_DEF (0)	Internally Grounded
7	Reset	CMOS input. Assert "Reset" high at the end of previous burst, 2 bytes in duration
8	BRST_Det	LVTTL output. BRST_Det assert low when module receives "reset" signal, assert high when incoming burst is present.
9	RSSI_ACQ	RSSI acquire/hold LVTTL Input. Digital RSSI output through I2C
10	Veer	Rx Ground
11	Veer	Rx Ground
12	RXD-	Negative Data Output, LVPECL; DC coupled
13	RXD+	Positive Data Output, LVPECL; DC coupled
14	Veer	Rx Ground
15	Vcc_Rx	Rx Vcc
16	Vcc_Tx	Tx Vcc
17	Veet	Tx Ground
18	TXD+	Positive Data Input, LVPECL or CML (AC coupled; internally 100 ohms differential termination)
19	TXD-	Negative Data Input, LVPECLor CML (AC coupled; internally 100 ohms differential termination)
20	Veet	Tx Ground



1490nm/1310nm Single Fiber OLT

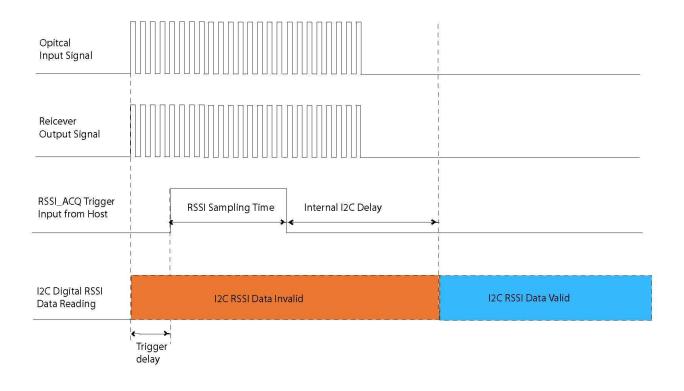
#### **Timing Diagram**





1490nm/1310nm Single Fiber OLT

#### **Digital RSSI Acquire/Hold Timing Specification**





1490nm/1310nm Single Fiber OLT

#### Table 8 - EEPROM Content (A0h)

I2C A	Oh Addre	ess			
DEC Addr.	HEX Addr.	Field Size (bytes)	Name	Default Value	Description
0	00	1	Identifier	03h	SFP Transceiver
1	01	1	Extended Identifier	04h	Function defined by serial ID
2	02	1	Connector	01h	SC Receptacle
3	03	8	Transceiver	00 00 00 00 00 00 00 00h	Transceiver Code Field, not applicable
11	ОВ	1	Encoding	03h	NRZ encoding
12	0C	1	Nominal Bit Rate in 100 MBps	19h	2488.32 Mbps
13	0D	1	Reserved	00h	Reserved
14	0E	1	Length (9µ,km) in km	14h	20km
15	OF	1	Length (9µ,m) in 100m	C8h	20km
16	10	1	Length (50μ) in 10m	00h	Not Supported
17	11	1	Length (62.5μ) in 10m	00h	Not Supported
18	12	1	Length (Copper) in m	00h	Not Supported
19	13	1	Reserved	00h	Reserved
20	14	16	Vendor Name (ASCII)	"SOURCEPHOTONICS"	Vendor Name (ASCII)
36	24	1	Reserved	00h	Reserved
37	25	3	Vender IEEE Company ID	00 06 B5h	Source Photonics IEEE ID
40	28	16	Vendor Part Number (ASCII)	"SPS4348HHPxDE"	Vendor Part Number (ASCII), x=R or T
56	38	4	Vendor Rev (ASCII)	31 20 20 20	Revision
60	3C	2	Laser Wavelength in nm	05 D2h	1490nm Tx Wavelength
62	3E	1	Reserved	00h	Reserved
63	3F	1	Check Code for Base ID Fields	xxh	Checksum from byte 0-62
64	40	2	Options	00 1Ch	TX_DIS, TX_Fault, SD
66	42	1	Upper Bit Rate Margin in %	00h	BR, Max not specified
67	43	1	Lower Bit Rate Margin in %	00h	BR, Min not specified
68	44	16	Vendor Serial Number (ASCII)	"xxxxxxxxxxxxx"	16 byte Serial number field (ASCII)



#### 1490nm/1310nm Single Fiber OLT

84	54	8	Date Code	xx xx xx xx xx xx 20 20h	Year(2 bytes) month(2		
					bytes) day(2 bytes)		
92	5C	1	Diagnostic Monitoring	58h	Ext Calibration, Average		
J		_	Туре	36.1	Power Measurement		
					Optical Alarm/warning		
93	5D	1	1 Enhanced Options	E0h	implemented Soft TX_DIS,		
					TX_FAULT implemented		
94	5E	1	1	1	CFF 0472 Compliance	02h	Compliance to SFF-8472
94	) JE	1	SFF-8472 Compliance	0211	Rev 9.4		
0.5	FF		Check Code for	suula.	Charles un franz la ta CA CO		
95	5F 1 Ext		Extended ID Fields	xxh	Checksum from byte 64-69		
96	60	26	Vendor Specific	"SPS-43-48H-HP-xDE"	SP Part Number, x= R or T		
126	7E	2	Vendor Specific	00 00h	Reserved		
128	80	128	Reserved	0000h	Reserved; return to 0		

Note: The "xx" byte should be filled in according to practical case. For more information, please refer to the related document of SFF-8472 Rev 9.5.

Table 9 - EEPROM Content (A2h)

I2C A2	I2C A2h Address								
DEC	HEX	Field Size	Name	Defects Value	Description				
Addr.	Addr.	(bytes)	Name	Default Value	Description				
0	00	2	Temp High Alarm	xx xxh	92C				
2	02	2	Temp Low Alarm	xx xxh	-48C				
4	04	2	Temp High Warning	xx xxh	87C				
6	06	2	Temp Low Warning	xx xxh	-43C				
8	08	2	Voltage High Alarm	94 70h	3.8V				
10	0A	2	Voltage Low Alarm	6D 60h	2.8V				
12	0C	2	Voltage High Warning	8C A0h	3.6V				
14	0E	2	Voltage Low Warning	75 30h	3.0V				
16	10	2	Bias High Alarm	83 81h	110mA				
18	12	2	Bias Low Alarm	02 64h	2mA				
20	14	2	Bias High Warning	77 8Ch	100mA				
22	16	2	Bias Low Warning	03 96h	3mA				
24	18	2	TX Power High Alarm	xx xxh	+5.5 dBm				
26	1A	2	TX Power Low Alarm	xx xxh	+0.5dBm				
28	1C	2	TX Power High Warning	xx xxh	+5.0dBm				
30	1E	2	TX Power Low Warning	xx xxh	+1.0dBm				
32	20	2	RX Power High Alarm	FF FFh	No alarm				



### 1490nm/1310nm Single Fiber OLT

34	22	2	RX Power Low Alarm	00 00h	No alarm
36	24	2	RX Power High Warning	FF FFh	No alarm
38	26	2	RX Power Low Warning	00 00h	No alarm
40	28	16	Reserved	00000h	Reserved
56	38	4	RX_PWR(4) Calibration	xx xx xx xxh	4 <sup>th</sup> order RSSI calibration coefficient
60	3C	4	RX_PWR(3) Calibration	xx xx xx xxh	3 <sup>rd</sup> order RSSI calibration coefficient
64	40	4	RX_PWR(2) Calibration	xx xx xx xxh	2nd order RSSI calibration coefficient
68	44	4	RX_PWR(1) Calibration	xx xx xx xxh	1 <sup>st</sup> order RSSI calibration coefficient
72	48	4	RX_PWR(0) Calibration	xx xx xx xxh	0 <sup>th</sup> order RSSI calibration coefficient
76	4C	2	TX_I(Slope) Calibration	01 A3h	Slope for Bias calibration
78	4E	2	TX_I(Offset) Calibration	00 00h	Offset for Bias calibration
80	50	2	TX_PWR(Slope) Calibration	xx xxh	Slope for TX Power calibration
82	52	2	TX_PWR(Offset) Calibration	xx xxh	Offset for TX Power calibration
84	54	2	T(Slope) Calibration	01 00h	Slope for Temperature calibration
86	56	2	T(Offset) Calibration	xx xxh	Offset for Temperature calibration, in units of 256ths C
88	58	2	V(Slope) Calibration	01 00h	Slope for VCC calibration
90	5A	2	V(Offset) Calibration	00 00h	Offset for VCC calibration
92	5C	3	Reserved	00h	reserved
95	5F	1	Checksum	xxh	Checksum
96	60	2	Transceiver Temperature	xx xxh	Temperature in C/256
98	62	2	Supply Voltage	xx xxh	Vcc
100	64	2	TX Bias Current	xx xxh	BIASMON
102	66	2	TX Optical Output Power	xx xxh	Back facet monitor
104	68	2	RX Optical Input Power	xx xxh	RSSI
106	6A	2	Reserved	0000h	Reserved
108	6C	2	Reserved	0000h	Reserved
110	6E.7	1bit	TX_DIS State	х	Digital state of the TX Disable Input Pin.
	6E.6	1bit	Soft TX Disable	x	Read/write bit that allows software disable of laser.
	6E.5	1bit	Reserved.	0	Reserved.
	6E.4	1bit	Rate Select State	0	NOT SUPPORTED.
	6E.3	1bit	Rate Select	0	NOT SUPPORTED.
	6E.2	1bit	TX_FAULT	х	Digital state of the TX Fault Output Pin.
	6E.1	1bit	LOS	0	Digital state of the LOS Output Pin.



### 1490nm/1310nm Single Fiber OLT

					NOT SUPPORTED
					Indicates transceiver has achieved
	6E.0	1bit	Data_ready_bar	x	power up and data is ready.
	6F.7	1bit	Reserved	0	Reserved
111	6F.6	1bit	Reserved	0	Reserved
	6F.5	1bit	Reserved	0	Reserved
	6F.4	1bit	Reserved	0	Reserved
	6F.3	1bit	Reserved	0	Reserved
	6F.2	1bit	INTERRUPT_NOT	X	Interrupt state (active low)
	6F.1	1bit	MODE_EN	0	TX FAULT pin enable
	01.1	IDIC	INIODE_EIN	U	APD shut-down latch. Write 0 to clear
	6F.0	1bit	APD_SHUTDOWN	x	condition
	70.7	1bit	Temperature too high alarm	х	Temperature too high alarm
	70.6	1bit	Temperature too low alarm	х	Temperature too low alarm
112	70.5	1bit	VCC too high alarm	x	VCC too high alarm
112	70.4	1bit	VCC too low alarm	х	VCC too low alarm
	70.3	1bit	BIASMON too high alarm	х	BIASMON too high alarm
	70.2	1bit	BIASMON too low alarm	х	BIASMON too low alarm
	70.1	1bit	BFMON too high alarm	х	BFMON too high alarm
	70	1bit	BFMON too low alarm	х	BFMON too low alarm
	71.7	1bit	RSSI too high alarm	х	RSSI too high alarm
	71.6	1bit	RSSI too low alarm	х	RSSI too low alarm
113	71.5	1bit	Reserved interrupt status bit	х	Reserved interrupt status bit
	71.4	1bit	Reserved interrupt status bit	х	Reserved interrupt status bit
	71.3	1bit	Reserved interrupt status bit	х	Reserved interrupt status bit
	71.2	1bit	Reserved interrupt status bit	х	Reserved interrupt status bit
	71.1	1bit	Reserved interrupt status bit	х	TX Fail went HIGH
	71	1bit	Reserved interrupt status bit	х	APD Shutdown event detected
114	72	1	Reserved	00h	Interrupt Mask for ISRC0
115	73	1	Reserved	00h	Interrupt Mask for ISRC1



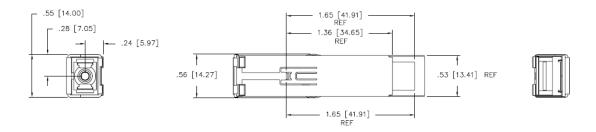
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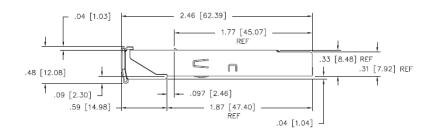
116	74.7	1bit	Temperature too high warning	x	Temperature too high warning
	74.6	1bit	Temperature too low warning		Temperature too low warning
	74.5	1bit	VCC too high warning	х	VCC too high warning
	74.4	1bit	VCC too low warning	х	VCC too low warning
	74.3	1bit	BIASMON too high warning	x	BIASMON too high warning
	74.2	1bit	BIASMON too low warning	x	BIASMON too low warning
	74.1	1bit	BFMON too high warning	х	BFMON too high warning
	74	1bit	BFMON too low warning	х	BFMON too low warning
	75.7	1bit	RX Power High Warning	х	RSSI too high warning
	75.6	1bit	RX Power Low Warning	х	RSSI too low warning
	75.5	1bit	Reserved	0	Reserved
117	75.4	1bit	Reserved	0	Reserved
11/	75.3	1bit	Reserved	0	Reserved
	75.2	1bit	Reserved	0	Reserved
	75.1	1bit	Reserved	0	Reserved
	75	1bit	Reserved	0	Reserved
118	76	1	Reserved	00h	Interrupt Mask for ISRC2
119	77	1	Reserved	00h	Interrupt Mask for ISRC3
120	78	8	Vendor Specific	00 00 00 00 00 00 00 00h	Vendor Specific



1490nm/1310nm Single Fiber OLT

#### **Package Diagram**









7

### SPS-43-48H-HP-xDE

1490nm/1310nm Single Fiber OLT

#### Table 12 - Device Handling/ESD Protection

The devices are static sensitive and may easily be damaged if care is not taken during handling. The following handling practices are

- Devices should be handled on benches with conductive and grounding surfaces.

  All personnel, test equipment and tools shall be grounded.

  Do not handle the devices by their leads.

  Store devices in protective foam or carriers.

  Avoid the use of non-conductive plastics, rubber, or silk in the area where the devices are handled

  All modules shall be packaged in materials that are anti-static to protect against adverse electrical environments.

  Avoid applications of any voltage higher than maximum rated voltages to this part. For proper operation, any VIN or VOUT should be
  - constrained to the range  $GND \le (VIN \text{ or } VOUT) \le VCC$ . Unused inputs must always be tied to an appropriate logic voltage (e.g. either GND or VCC). Unused outputs must be left open.



1490nm/1310nm Single Fiber OLT

#### **Warnings**

Handling Precautions: This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Follow guidelines according to proper ESD procedures.

Laser Safety: Radiation emitted by laser devices can be dangerous to human eyes. Avoid eye exposure to direct or indirect radiation.

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